

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE
Patent Application

I hereby certify that this transmittal of the below described documents is being deposited with the United States Postal Service in an envelope bearing Express Mail Postage and an Express Mail label, with the below serial number, addressed to the Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450, on the below date of deposit.			
Express Mail Label No.:	EV302956945US	Name of Person Making the Deposit:	Andrea Martinez
Date of Deposit:	7/11/03	Signature of the Person Making the Deposit:	<i>Andrea Martinez</i>

15563 U.S. PTO
10/618514

07/11/03

Inventor(s): **Imran Khan, Jianshi Wang, Yue-Song He, Jun Kang**

Title: **METHOD OF FABRICATING SEMICONDUCTOR DEVICE HAVING TRIPLE LDD STRUCTURE AND LOWER GATE RESISTANCE FORMED WITH A SINGLE IMPLANT PROCESS**

The Commissioner of Patents and Trademarks
Washington, D.C. 20231
Sir:

Transmittal of a Patent Application
(Under 37 CFR §1.53)

Transmitted herewith is the above identified patent application, including:

- ☒ Specification, claims and abstract, totaling 12 pages.
- ☐ Formal drawings, totaling _____ pages.
- ☒ Informal drawings, totaling 6 pages.
- ☒ Declaration and Power of Attorney.
- ☐ Information Disclosure statement.
- ☐ Form 1449
- ☒ Assignment(s)
- ☒ Assignment Recordation Form (duplicate)
- ☒ Request and Certification under 35 U.S.C. 122(b)(2)(B)(i)
- ☐ Other: _____

Amendments, Priority Claim

35 U.S.C. 119

☐ Priority of application Serial Number _____ filed on _____
in _____ is claimed under

35 U.S.C. 119.

☐ The certified copy has been filed in prior U.S. application Serial No. _____

☐ _____ in _____
☐ The certified copy will follow.

35 U.S.C. 120, 121 and 365(c)

"This application is a continuation of and claims the benefit of copending application(s)

☐ application number _____ filed on _____
☐ International Application _____ filed on _____

and which designated in the U.S."

☐ Amend this specification by inserting, before the first line, the following sentence:

"This application claims priority to the copending application(s)

☐ Serial Number _____ filed on _____

which is hereby incorporated by reference to this specification

☐ International Application _____ filed on _____

which designated the U.S."

FEES DUE

The fees due for filing the specification pursuant to 37 C.F.R. § 1.16 and for recording of the Assignment, if any, are determined as follows:

CLAIMS					
	NO. OF CLAIMS		EXTRA CLAIMS	RATE	FEES
Basic Application Fee					\$750.00
Total Claims	21	Minus 20=	1	X \$18 =	\$18.00
Independent Claims	3	Minus 3=	0	X \$84=	\$0.00
If multiple dependent claims are presented, add \$260.00					
Add Assignment Recording Fee of \$40.00 If Assignment document is enclosed					\$40.00
TOTAL APPLICATION FEE DUE					\$808.00

PAYMENT OF FEES

The full fee due in connection with this communication is provided as follows:

1. Not enclosed

[] No filing fee is to be paid at this time.

2. Enclosed

[X] Filing fee

[X] Recording assignment

[X] The Commissioner is hereby authorized to charge any additional fees associated with this communication or credit any overpayment to Deposit Account No.: 23-0085. A duplicate copy of this authorization is enclosed.

[X] A check in the amount of \$808.00

- ☐ Charge any fees required or credit any overpayments associated with this filing to Deposit Account No.: 23-0085.

This application is filed pursuant to 37 C.F.R. § 1.53 in the name of the above-identified Inventor(s).


Please direct all correspondence concerning the above-identified application to the following address:

WAGNER, MURABITO & HAO LLP
Two North Market Street, Third Floor
San Jose, California 95113
(408) 938-9060

- ☒ This transmittal ends with this page.

Respectfully submitted,

Date: July 11, 2003

By: 
José S. Garcia
Reg. No. 43,628

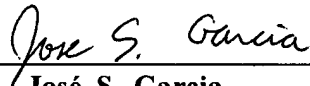
Inventor(s): **Imran Khan, Jianshi Wang, Yue-Song He, Jun Kang**

Title: **METHOD OF FABRICATING SEMICONDUCTOR DEVICE HAVING
TRIPLE LDD STRUCTURE AND LOWER GATE RESISTANCE FORMED
WITH A SINGLE IMPLANT PROCESS**

**REQUEST AND CERTIFICATION
UNDER 35 U.S.C. 122(b)(2)(B)(i)**

I hereby certify that the invention disclosed in the attached application **has not and will not be** the subject of an application filed in another country, or under a multilateral agreement, that requires publication at eighteen months after filing. I hereby request that the attached application not be published under 35 U.S.C. 122(b).

Date: July 11, 2003

By: 
José S. Garcia
Reg. No. 43,628

This request must be signed in compliance with 37 CFR 1.33(b) and submitted with the application **upon filing**.

Applicant may rescind this nonpublication request at any time. If applicant rescinds a request that an application not be published under U.S.C. 122(b), the application will be scheduled for publication at eighteen months from the earliest claimed filing date for which a benefit is claimed.

If applicant subsequently files an application directed to the invention disclosed in the attached application in another country, or under a multilateral international agreement, that requires publication of applications eighteen months after filing, the applicant must notify the United States Patent and Trademark Office of such filing within forty-five (45) days after the date of the filing of such foreign or international application. **Failure to do so will result in abandonment of this application (35 U.S.C. 122(b)(2)(B)(iii)).**